



## Features

- Ultra-low resistance, quick response
- 0805 footprint size and low profile for space-constrained mobile applications
- Surface mount packaging for automated assembly
- RoHS compliant\* and halogen free\*\*
- Agency recognition:  

## Applications

- USB port protection - USB 2.0, 3.0 & OTG
- HDMI 1.4 Source protection
- PC motherboards - Plug & Play protection
- Mobile phones - battery & port protection
- PDAs / digital cameras
- Wireless headphone power protection
- Game console port protection

# MF-PSML/X Series - Low Ohmic PTC Resettable Fuses

## Electrical Characteristics

Model	V <sub>max</sub>	I <sub>max</sub>	I <sub>hold</sub>	I <sub>trip</sub>	Resistance		Max. Time To Trip		Tripped Power Dissipation	Agency Recognition	
					at 23 °C		at 23 °C			Watts at 23 °C	cUL
			Volts	Amps	Amps	R <sub>min</sub>	R <sub>1max</sub>	Amps	Seconds	Typ.	E174545
MF-PSML075/12	12	50	0.75	1.5	0.040	0.300	8.0	0.2	0.7	✓	✓
MF-PSML110/12	12	50	1.1	2.2	0.030	0.210	8.0	0.3	0.7	✓	✓
MF-PSML125/12	12	50	1.25	2.5	0.020	0.160	8.0	0.4	0.7	✓	✓
MF-PSML150/12	12	50	1.5	3.0	0.015	0.080	8.0	0.5	0.7	✓	✓
MF-PSML175/12	12	50	1.75	3.5	0.010	0.065	8.0	1.0	0.7	✓	✓
MF-PSML200/12	12	50	2.0	4.0	0.005	0.050	8.0	2.0	0.8	✓	✓
MF-PSML250/12	12	50	2.5	5.0	0.003	0.040	8.0	2.0	0.8	✓	✓
MF-PSML260/12	12	50	2.6	5.2	0.003	0.030	8.0	4.0	0.8	✓	✓
MF-PSML300/12	12	50	3.0	6.0	0.003	0.020	8.0	5.0	0.8	✓	✓
MF-PSML350/8	8	50	3.5	7.0	0.002	0.018	8.0	5.0	0.9	✓	✓
MF-PSML380/8	8	50	3.8	7.6	0.001	0.016	8.0	5.0	0.9	✓	✓
MF-PSML400/8	8	50	4.0	8.0	0.001	0.014	8.0	12.5	0.9	✓	✓
MF-PSML450/8	8	50	4.5	9.0	0.001	0.012	8.0	12.5	0.9	✓	✓

## Environmental Characteristics

Operating Temperature.....	-40 °C to +85 °C
Storage Condition	
Before Opening .....	+40 °C max. / 70 % RH max.
After Opening .....	+40 °C max. / 10 % RH max.
Floor Condition After Opening .....	Consumption within 4 weeks at floor condition +30 °C max. / 60 % RH max.
Passive Aging .....	+85 °C, 1000 hours..... ±10 % typical resistance change
Humidity Aging.....	+85 °C, 85 % R.H. 100 hours ..... ±15 % typical resistance change
Thermal Shock .....	-40 °C to +85 °C, 20 times..... ±30 % typical resistance change
Solvent Resistance.....	MIL-STD-202, Method 215 ..... No change (marking still legible)
Vibration .....	MIL-STD-883C, Method 2007.1, Condition A ..... No change (R <sub>min</sub> <R<R <sub>1max</sub> )
Moisture Sensitivity Level (MSL) .....	<a href="#">See Note</a>
ESD Classification .....	Class 6 (per AEC-Q200-2 HBM)

## Test Procedures and Requirements

Test	Test Conditions	Accept/Reject Criteria
Visual/Mech. ....	Verify dimensions and materials.....	Per MF physical description
Resistance .....	In still air @ 23 °C.....	R <sub>min</sub> ≤ R ≤ R <sub>1max</sub>
Time to Trip.....	At specified current, V <sub>max</sub> , 23 °C.....	T ≤ max. time to trip (seconds)
Hold Current .....	30 min. at I <sub>hold</sub> .....	No trip
Trip Cycle Life.....	V <sub>max</sub> , I <sub>max</sub> , 100 cycles.....	No arcing or burning
Trip Endurance .....	V <sub>max</sub> , 48 hours .....	No arcing or burning
Solderability .....	245 °C ±5 °C, 5 seconds .....	95 % min. coverage



**WARNING Cancer and Reproductive Harm - [www.P65Warnings.ca.gov](http://www.P65Warnings.ca.gov)**

\* RoHS Directive 2015/863, Mar 31, 2015 and Annex.

\*\* Bourns considers a product to be "halogen free" if (a) the Bromine (Br) content is 900 ppm or less; (b) the Chlorine (Cl) content is 900 ppm or less; and (c) the total Bromine (Br) and Chlorine (Cl) content is 1500 ppm or less.

Specifications are subject to change without notice.

Users should verify actual device performance in their specific applications.

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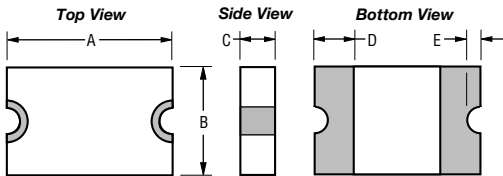
# MF-PSML/X Series - Low Ohmic PTC Resettable Fuses

**BOURNS®**

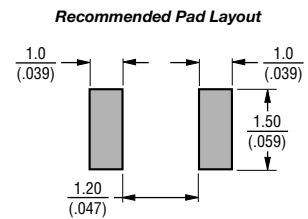
## Product Dimensions

Model	A		B		C		D	E	
	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Min.	Max.
MF-PSML075/12	$\frac{2.00}{(0.079)}$	$\frac{2.30}{(0.091)}$	$\frac{1.20}{(0.047)}$	$\frac{1.50}{(0.059)}$	$\frac{0.30}{(0.012)}$	$\frac{0.70}{(0.028)}$	$\frac{0.20}{(0.008)}$	$\frac{0.05}{(0.002)}$	$\frac{0.45}{(0.018)}$
MF-PSML110/12									
MF-PSML125/12									
MF-PSML150/12									
MF-PSML175/12									
MF-PSML200/12	$\frac{2.00}{(0.079)}$	$\frac{2.30}{(0.091)}$	$\frac{1.20}{(0.047)}$	$\frac{1.50}{(0.059)}$	$\frac{0.60}{(0.024)}$	$\frac{1.40}{(0.055)}$	$\frac{0.20}{(0.008)}$	$\frac{0.05}{(0.002)}$	$\frac{0.45}{(0.018)}$
MF-PSML250/12									
MF-PSML260/12									
MF-PSML300/12									
MF-PSML350/8									
MF-PSML380/8									
MF-PSML400/8									
MF-PSML450/8									

DIMENSIONS:  $\frac{\text{MM}}{\text{(INCHES)}}$



Terminal material:  
ENIG-plated terminals



## Packaging Quantity

MF-PSML075/12 ~ MF-PSML175/12 = 4,500 pcs. per reel  
MF-PSML200/12 ~ MF-PSML450/8 = 3,000 pcs. per reel

# MF-PSML/X Series - Low Ohmic PTC Resettable Fuses



**Thermal Derating Table - I<sub>hold</sub> (Amps)**

Model	Ambient Operating Temperature								
	-40 °C	-20 °C	0 °C	23 °C	40 °C	50 °C	60 °C	70 °C	85 °C
MF-PSML075/12	1.12	1.01	0.95	0.75	0.64	0.58	0.52	0.47	0.37
MF-PSML110/12	1.65	1.48	1.40	1.10	0.94	0.85	0.77	0.69	0.55
MF-PSML125/12	1.87	1.69	1.59	1.25	1.06	0.96	0.87	0.79	0.62
MF-PSML150/12	2.25	2.02	1.90	1.50	1.28	1.16	1.05	0.94	0.75
MF-PSML175/12	2.62	2.36	2.22	1.75	1.49	1.35	1.22	1.10	0.87
MF-PSML200/12	2.99	2.70	2.54	2.00	1.70	1.54	1.39	1.26	0.99
MF-PSML250/12	3.75	3.38	3.18	2.50	2.13	1.92	1.75	1.57	1.24
MF-PSML260/12	3.89	3.51	3.30	2.60	2.21	2.01	1.81	1.63	1.29
MF-PSML300/12	4.49	4.05	3.80	3.00	2.55	2.31	2.09	1.89	1.49
MF-PSML350/8	5.24	4.72	4.44	3.50	2.98	2.70	2.44	2.20	1.74
MF-PSML380/8	5.69	5.12	4.82	3.80	3.24	2.93	2.65	2.39	1.89
MF-PSML400/8	5.99	5.39	5.07	4.00	3.41	3.09	2.79	2.51	1.99
MF-PSML450/8	6.74	6.07	5.71	4.50	3.83	3.47	3.14	2.83	2.24

## How to Order



## Typical Part Marking

Represents total content. Layout may vary.



Manufacturing date code is located on packaging label

## Solder Reflow Recommendations



### Notes:

- MF-PSML/X models are intended for reflow soldering (including, but not limited to heating plate, hot air, IR, nitrogen, and vapor phase).
- Wave soldering is permissible only if the device is on the top of the PCB, opposite the heat source.
- Hand soldering is not recommended for these devices.
- All temperatures refer to the topside of the device, measured on the device body surface.
- If reflow temperatures exceed the recommended profile, devices may not meet the published specifications.
- Compatible with Pb and Pb-free solder reflow profiles.
- Excess solder may cause a short circuit.
- Please refer to the [Multifuse® Polymer PTC Resettable Fuse Soldering Recommendations](#) document for more details.

Profile Feature	Pb-Free Assembly
Average Ramp-Up Rate ( $T_{S_{max}}$ to $T_P$ )	3 °C / second max.
PREHEAT: Temperature Min. ( $T_{S_{min}}$ ) Temperature Max. ( $T_{S_{max}}$ ) Time ( $T_{S_{min}}$ to $T_{S_{max}}$ ) (ts)	150 °C 200 °C 60~180 seconds
TIME MAINTAINED ABOVE: Temperature ( $T_L$ ) Time ( $t_L$ )	217 °C 60~150 seconds
Peak Temperature ( $T_P$ )	260 °C
Time within 5 °C of Actual Peak Temperature ( $t_p$ )	20~40 seconds
Ramp-Down Rate	6 °C / second max.
Time 25 °C to Peak Temperature	8 minutes max.

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# MF-PSML/X Series - Low Ohmic PTC Resettable Fuses

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## Packaging Specifications

MF-PSML/X Series per EIA-481



DIMENSIONS:  $\frac{\text{MM}}{\text{(INCHES)}}$

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MF-PSML/X SERIES, REV. A, 05/19

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**Application Notice**

- Users are responsible for independent and adequate evaluation of Bourns® Multifuse® Polymer PTC devices in the user's application, including the PPTC device characteristics stated in the applicable data sheet.
- Polymer PTC devices must not be allowed to operate beyond their stated maximum ratings. Operation in excess of such maximum ratings could result in damage to the PTC device and possibly lead to electrical arcing and/or fire. Circuits with inductance may generate a voltage above the rated voltage of the polymer PTC device and should be thoroughly evaluated within the user's application during the PTC selection and qualification process.
- Polymer PTC devices are intended to protect against adverse effects of temporary overcurrent or overtemperature conditions up to rated limits and are not intended to serve as protective devices where overcurrent or overvoltage conditions are expected to be repetitive or prolonged.
- In normal operation, polymer PTC devices experience thermal expansion under fault conditions. Thus, a polymer PTC device must be protected against mechanical stress, and must be given adequate clearance within the user's application to accommodate such thermal expansion. Rigid potting materials or fixed housings or coverings that do not provide adequate clearance should be thoroughly examined and tested by the user, as they may result in the malfunction of polymer PTC devices if the thermal expansion is inhibited.
- Exposure to lubricants, silicon-based oils, solvents, gels, electrolytes, acids, and other related or similar materials may adversely affect the performance of polymer PTC devices.
- Aggressive solvents may adversely affect the performance of polymer PTC devices. Conformal coating, encapsulating, potting, molding, and sealing materials may contain aggressive solvents including but not limited to xylene and toluene, which are known to cause adverse effects on the performance of polymer PTCs. Such aggressive solvents must be thoroughly cured or baked to ensure their complete removal from polymer PTCs to minimize the possible adverse effect on the device.
- Recommended storage conditions should be followed at all times. Such conditions can be found on the applicable data sheet and on the Multifuse® Polymer PTC Moisture/Reflow Sensitivity Classification (MSL) note:  
[https://www.bourns.com/docs/RoHS-MSL/msl\\_mf.pdf](https://www.bourns.com/docs/RoHS-MSL/msl_mf.pdf)

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